

# Alpha Bridge AQSOH-T-01-PCV Datasheet





## Features

- Up to 800Gb/s data rate
- 8x100Gb/s PAM4 modulation
- Compatible to QSFP-DD Hardware Specification
- Compatible to IEEE802.3cK
- Hot-pluggable
- Power Supply Voltage: 3.3W
- RoHS compliant
- Operating temperature range: 0°C to 70°C

## Application

- Switches, Servers, Routers, Storage Arrays
- Networking Equipment
- Data Cables
- Telecommunications Central Offices
- Test and Measurement Equipment
- Test and Measurement Equipment

## Description

AlphaBridge QSFP-DD800 (Double Density) Passive Direct Attach Copper Cable features 8 transmitting and 8 receiving 100Gbps PAM4 channels for 800G operation. The cable assembly meets IEEE 802.3ck 400GBase -CR4, 200Gbase-CR2, and 100GBase-CR1 standards with substantial signal integrity margin providing high performance and bandwidth interconnect solutions for high-density applications.

As next-gen data centers deploy faster speed in a tighter space, they need high-performance cables that reduce power consumption, provide reliable operation, and are low-cost. AlphaBridge QSFP-DD800 cable is designed to meet the next-gen data center needs. With unique foam dielectric construction, Volex QSFP-DD800 cable offers the smallest cable outer diameter and bend radius, and the highest flexibility, while meeting or exceeding the MSA signal integrity specification.

## Absolute Maximum Ratings

Parameter	Symbol	Min.	Typ.	Max.	Units
Storage Temperature	<i>TS</i>	-40		85	°C
Supply Voltage	<i>VCC3</i>	3.135		3.465	V
Relative Humidity (non-condensation)	<i>RS</i>	5		85	%

## Recommended Operating Conditions & Power Supply Requirements

Parameter	Symbol	Min.	Typ.	Max.	Units
Operating Case Temperature	<i>TOP</i>	0		70	°C
Power Supply Voltage	<i>VCC3</i>	3.135		3.465	V
Voltage on LVTTTL Input	<i>Vilvttl</i>	-0.3		VCC3 +0.2	V

Power Supply Current	Icc3	0.001			mA
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## Frequency Domain

Item	Test Parameter	IEEE802.3ck Specification
1	Differential Insertion Loss (SDD21)	Maximum insertion loss at 26.56GHz -19.75dB Minimum insertion loss at 26.56GHz -11dB
2	Common Mode Reflection (SCC11/SCC22)	-1.4dB @ 0.05 to 6GHz -0.68-0.12*(f) @ 6 to 30GHz -10.28+0.2*(f) @ 30 to 40GHz
3	Common Mode Conversion (SCD11/SCD22)	-22+(10/25.56)*(f) @ 0.05 to 26.56GHz -15+(3/25.56)*(f) @ 26.56 to 40GHz
4	Differential to Common Mode Conversion Loss (SCD21-SDD21)	-10dB @ 0.05 to 12.89GHz -14+0.3108*(f) @ 12.89 to 40GHz
5	Channel Operating Margin (COM)	3dB Minimum
6	Effective Return Loss (ERL)	* 8.25 dB Minimum. Cable assemblies with a COM greater than 4 dB are notrequired to meet minimum ERL
7	Insertion Loss* (SDD21) for 0.5M 30awg	25.65GHz : -14.55 dB Max
	Insertion Loss* (SDD21) for 1.0M 28awg	25.65GHz : -16.75 dB Max
	Insertion Loss* (SDD21) for 1.5M 26awg	25.65GHz : -17.45 dB Max
	Insertion Loss* (SDD21) for 2.0M 26awg	25.65GHz : -19.75 dB Max

## Pin Description

Pin#	Symbol	Description	Logic	Direction	Plug Sequence	Notes
1	GND	Ground			1	
2	TX2p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
3	TX2n	Transmitter Data Inverted	CML-I	Input from Host	3	
4	GND	Ground			1	
5	TX4p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
6	TX4n	Transmitter Data Inverted	CML-I	Input from Host	3	
7	GND	Ground			1	
8	TX6p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
9	TX6n	Transmitter Data Inverted	CML-I	Input from Host	3	
10	GND	Ground			1	
11	TX8p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
12	TX8n	Transmitter Data Inverted	CML-I	Input from Host	3	
13	GND	Ground			1	
14	SCL	2-wire Serial interface clock	LVC MOS-I/O	Bi-directional	3	Open-Drain with pull-up resistor on Host
15	VCC	+3.3V Power		Power from Host	2	
16	VCC	+3.3V Power		Power from Host	2	

17	LPWn/PR Sn	Low-Power Mode / Module Present	Multi-Level	Bi-directional	3	See pin description for required circuit
18	GND	Ground			1	
19	RX7n	Receiver Data Inverted	CML-O	Output to Host	3	
20	RX7p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
21	GND	Ground			1	
22	RX5n	Receiver Data Inverted	CML-O	Output to Host	3	
23	RX5p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
24	GND	Ground			1	
25	RX3n	Receiver Data Inverted	CML-O	Output to Host	3	
26	RX3p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
27	GND	Ground			1	
28	RX1n	Receiver Data Inverted	CML-O	Output to Host	3	
29	RX1p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
30	GND	Ground			1	

Note:

#### LPWn/PRSn:

LPWn/PRSn is a dual-function signal that allows the host to signal Low Power mode and the module to indicate Module Present. The circuit shown in Figure 13-5 enables multi-level signaling to provide direct signal control in both directions. Low Power mode is an active-low signal on the host which gets converted to an active-low signal on the module. Module Present is controlled by a pull-down resistor on the module which gets converted to an active-low logic signal on the host.

31	GND	Ground			1	
32	RX2p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
33	RX2n	Receiver Data Inverted	CML-O	Output to Host	3	
34	GND	Ground			1	
35	RX4p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
36	RX4n	Receiver Data Inverted	CML-O	Output to Host	3	
37	GND	Ground			1	
38	RX6p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
39	RX6n	Receiver Data Inverted	CML-O	Output to Host	3	
40	GND	Ground			1	
41	RX8p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
42	RX8n	Receiver Data Inverted	CML-O	Output to Host	3	
43	GND	Ground			1	
44	INT/RSTn	Module Interrupt / Module Reset	Multi-Level	Bi-directional	3	See the pin description for required circuit
45	VCC	+3.3V Power	Power from Host	2		
46	VCC	+3.3V Power	Power from Host	2		
47	SDA	2-wire Serial interface data	LVCMOS-I/O	Bi-directional	3	Open-Drain with a pull-up resistor on the Host
48	GND	Ground			1	
49	TX7n	Transmitter Data Inverted	CML-I	Input from Host	3	

50	TX7p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
51	GND	Ground			1	
52	TX5n	Transmitter Data Inverted	CML-I	Input from Host	3	
53	TX5p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
54	GND	Ground			1	
55	TX3n	Transmitter Data Inverted	CML-I	Input from Host	3	
56	TX3p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
57	GND	Ground			1	
58	TX1n	Transmitter Data Inverted	CML-I	Input from Host	3	
59	TX1p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
60	GND	Ground			1	

Note:

#### SDA and SCL:

SCL and SDA are a 2-wire serial interface between the host and module using the I2C or I3C protocols. SCL is defined as the serial interface clock signal and SDA as the serial interface data signal. Both signals are open -drain and require pull-up resistors to +3.3V on the host. The pull-up resistor value shall be 1k ohms to 4.7k ohms depending on capacitive load.

#### INT/RSTn:

INT/RSTn is a dual-function signal that allows the module to raise an interrupt to the host and also allows the host to reset the module. The circuit shown in Figure 13-3 enables multi-level signaling to provide direct signal control in both directions. Reset is an active-low signal on the host which is translated to an active-low signal on the module. An interrupt is an active-high signal on the module which gets translated to an active-high signal on the host

## Pin Assignment

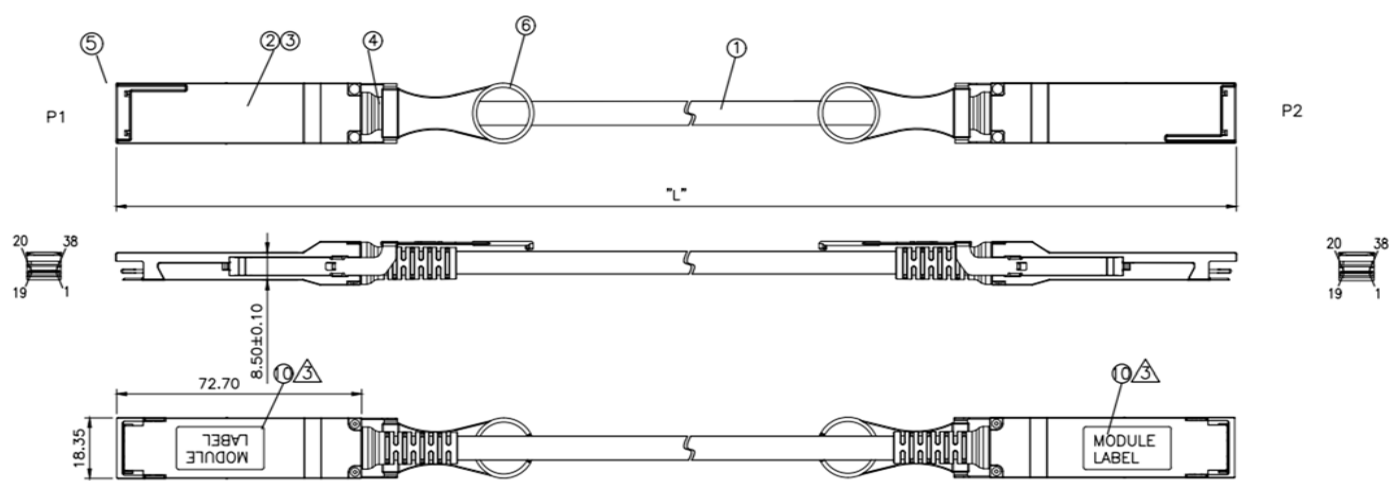
**Top Side (viewed from top)**

60	GND	
59	TX1p	
58	TX1n	
57	GND	
56	TX3p	
55	TX3n	
54	GND	
53	TX5p	
52	TX5n	
51	GND	
50	TX7p	
49	TX7n	
48	GND	
47	SDA	
46	VCC	
45	VCC	
44	INT/RSTn	
43	GND	
42	RX8n	
41	RX8p	
40	GND	
39	RX6n	
38	RX6p	
37	GND	
36	RX4n	
35	RX4p	
34	GND	
33	RX2n	
32	RX2p	
31	GND	

----- Module Card Edge -----

**Bottom Side (viewed from bottom)**

	GND	1
	TX2p	2
	TX2n	3
	GND	4
	TX4p	5
	TX4n	6
	GND	7
	TX6p	8
	TX6n	9
	GND	10
	TX8p	11
	TX8n	12
	GND	13
	SCL	14
	VCC	15
	VCC	16
	LPWn/PRSn	17
	GND	18
	RX7n	19
	RX7p	20
	GND	21
	RX5n	22
	RX5p	23
	GND	24
	RX3n	25
	RX3p	26
	GND	27
	RX1n	28
	RX1p	29
	GND	30



Ordering Information

Model Number	Part Number	AWG	Length	Temperature
800G OSFP DAC-1M	AQSOH-T-01-PCV	28	1M	0 °C to 70 °C

Note: All information contained in this document is subject to change without notice.